

**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1-9. (Cancelled)

10. (Previously Presented) A wiring connection method for an electronic apparatus containing electronic parts requiring large current for driving, the method comprising:

providing a housing of the electronic apparatus;

placing a substrate, on which the electronic parts are mounted, in the housing;

welding a harness and a bus bar that wires inside the electronic apparatus and leads out wiring to outside the housing;

integrally molding the bus bar with the housing; and

integrally molding a point where the harness and the bus bar are welded, with the housing.

11. (Previously Presented) The wiring connection method according to claim 10, wherein the welding includes welding the harness and the bus bar outside the housing.

12. (Previously Presented) The wiring connection method according to claim 10, wherein:

a jacket covers the harness; and

a heat resisting tube is put on the jacket.

13. (Previously Presented) A wiring connection structure or an electronic apparatus containing electronic parts requiring large current for driving, the structure comprising:

a housing of the electronic apparatus in which a substrate including the electronic parts is placed;

a bus bar that wires inside the electronic apparatus and leads out wiring to outside the housing;

a harness that is welded to the bus bar, wherein:

the bus bar is integrally molded with the housing; and

a point where the harness and the bus bar are welded is integrally molded with the housing.

14. (Previously Presented) The wiring connection structure according to claim 13, wherein the harness and the bus bar are welded outside the housing.

15. (Previously Presented) The wiring connection structure according to claim 13, further comprising:

a jacket that covers the harness; and

a heat resisting tube that is put on the jacket.

16. (Previously Presented) The method according to claim 1, wherein the housing defines a cavity.

17. (Previously Presented) The structure according to claim 3, wherein the housing defines a cavity.

18. (Previously Presented) The method according to claim 10, wherein the housing defines a cavity.

19. (Previously Presented) The structure according to claim 13, wherein the housing defines a cavity.

20. (Previously Presented) The wiring connection method according to claim 10, wherein the harness is attached at opposite end portions of the housing.

21. (Previously Presented) The wiring connection method of claim 10, wherein one end of the harness is electrically connected to an electronic circuit substrate within the housing.

22. (Previously Presented) The wiring connection method according to claim 13, wherein the harness is attached at opposite end portions of the housing.

23. (Previously Presented) The wiring connection method of claim 13, wherein one end of the harness is electrically connected to an electronic circuit substrate within the housing.